

ICCCAS 2024



Xiamen, China | May 10-12, 2024

CALL FOR PAPERS

The 13th International Conference on Communications, Circuits and Systems

Important Dates

Submission Deadline	February 5, 2024
Notification Deadline	March 1, 2024
Registration Deadline	March 15, 2024

ICCCAS Special Sessions

Session 1: Analog/Mixed-Signal/Power/RF Circuits and Related Technologies

Chair: Haruo Kobayashi (SMIEEE), Gunma University, Japan

Session 2: Wireless AI: Intelligent Wireless Sensing and Positionin

Chair: Zan Li, Jilin University, China

Session 3: Micro/Nano-structure Based Optoelectronics and Photonics Devices

Chair: Zhengji Xu, Sun Yat-sen University, China

Session 4: Integrated Technology for Maritime Positioning, Navigation, Timing, Communication and Remote Sensing

Chair: Anmin Zhang, Tianjin University, China & Bofeng Guo, Tianjin University, China

Session 5: Quantum Information Security

Chair: Randy Kuang, Quantropi Inc., Ottawa, Canada

Session 6: 6G Wireless Communication Networks

Chair: Jie Huang, Southeast University, China

Session 7: Biomedical Instrumentation and Signal Processing for Disease Diagnosis, Prognosis, and Treatment

Chair: Md Kafiul Islam (SMIEEE), Independent University, Bangladesh

Session 8: Underwater Acoustic Communications and Signal Processing

Chair: Lu Ma, Harbin Engineering University, China

Keynote Speakers



Prof. Chengxiang Wang, Southeast University, China

Fellow of the Royal Society of Edinburgh, IEEE, IET and China Institute of Communications



Prof. Wei Zhang, The University of New South Wales, Australia

Fellow of IEEE, IET & Vice President, IEEE Communications Society



Prof. Mohamad Sawan, Westlake University, China

Fellow of the Royal Society of Canada, IEEE, Canadian Academy of Engineering

Conference Awards

- ◆ Outstanding Young Scholar Award – **Deadline: April 10, 2024**
Eligibility: Authors within the age of 40 by May 13 with a doctor degree.
- ◆ Best Reviewer Award
- ◆ Best Student Paper Award (Eligibility: University Students Only)
- ◆ Best Paper Award (Eligibility: All Conference Accepted Papers)
- ◆ Excellent Oral Presentation Award
- ◆ Excellent Poster Presentation Award

For details, please visit: <http://www.icccas.org/award.html>


Publication

The accepted and presented papers will be published in the **ICCCAS Conference Proceedings**.


SCI/Scopus Journal Publication

Selected registered papers with proper extension will be recommended to below journals for potential publication


>> Sensors (ISSN 1424-8220)

 **sensors** **Impact Factor: 3.847**
an Open Access Journal by MDPI
Indexing: **SCIE (Web of Science), Scopus, Ei Compendex, PubMed, Inspec, etc.**

>> Journal of Communications (ISSN: 1796-2021)

 **CiteScore: 2.3**
Abbreviated Title: J. Commun.
Indexing: **Scopus, DBLP, CrossRef, EBSCO, Google Scholar, CNKI, etc.**

Publication History

 **IEEE** Accepted and presented papers of **11-year ICCCAS** have been successfully published into **IEEE**, included in **IEEE Xplore** and indexed by **EI Compendex & Scopus**.

ICCCAS 2022: Online - ISBN: 978-1-6654-6989-0 (**The papers were published 2 months and were indexed 1 month after conference.**)

ICCCAS 2018: Chengdu, China - ISBN: 978-1-5386-9387-2

ICCCAS 2013: Chengdu, China - ISBN: 978-1-4799-3051-7

ICCCAS 2010: Chengdu, China - ISBN: 978-1-4244-8224

ICCCAS 2009: Milpitas, CA, USA - ISBN: 978-1-4244-4886-9

ICCCAS 2008: Xiamen, China - ISBN: 978-1-4244-2063-6

ICCCAS 2007: Kokura, Japan - ISBN: 978-1-4244-1473-4

ICCCAS 2006: Guilin, China - ISBN: 0-7803-9584-0

ICCCAS 2005: Hong Kong, China - ISBN: 0-7803-9015-6

ICCCAS 2004: Chengdu, China - ISBN: 0-7803-8647-7

ICCCAS 2002: Chengdu, China - ISBN: 0-7803-7547-5

More info, please visit: <http://www.icccas.org/history.html>

Conference Topics

Communications

Communication and Information System Security
Communication Software and Multimedia
Molecular, Biological and Multi-Scale Communications
Green Communication Systems and Networks

Circuits and Systems

Beyond CMOS: Nanoelectronics and Hybrid Systems Integration
Neural Networks and Neuromorphic Engineering
Analog and Mixed Signal Circuits and Systems

More details, please access: <http://www.icccas.org/cfp.html>

Submission Guidelines

Submission Type:

Full Paper (**English, no less than 4 pages normally**, 10 pages maximum. 5-6 pages are recommended)

Abstract (English, within 300 words)

Submission Method:

EC Online Submission System:

<https://easychair.org/conferences/?conf=icccas2024>

Email Submission: icccas@vip.163.com

More details, please access: <http://www.icccas.org/sub.html>

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Invited Speakers



Yoshiaki Daimon Hagiwara (FIEEE)
Sojo University, Japan



Haruo Kobayashi (SMIEEEE)
Gunma University, Japan



Hitoshi Aoki (SMIEEEE)
Rohm Semiconductor, Japan



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Tokyo City University, Japan



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University of Tokyo, Japan



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